TOSHIBA Schottky Barrier Diode

CRS15

Switching Mode Power Supply Applications Portable Equipment Battery Applications

Repetitive peak reverse voltage : VRRM = 30 V Forward current $: I_{F(DC)} = 3 A$ Peak forward voltage $: V_{FM} = 0.52 \text{ V (max)}$

Small, thin package suitable for high-density board assembly

Toshiba Nickname: "S-FLAT $^{\mathrm{TM}}$ "

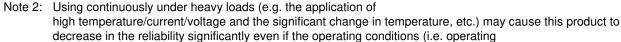
Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V _{RRM}	30	٧
Forward current (DC)	IF (DC)	3 (Note 1)	Α
Non-repetitive peak forward surge current	IFSM	30 (50 Hz)	Α
Junction temperature	Tj	-40 to 150	°C
Storage temperature	T _{stg}	-40 to 150	°C

Note 1: Ta = 69°C: Device mounted on a ceramic board

Board size : $50 \text{ mm} \times 50 \text{ mm}$ Soldering land size : 2 mm × 2 mm Board thickness : 0.64 mm

DC waveform



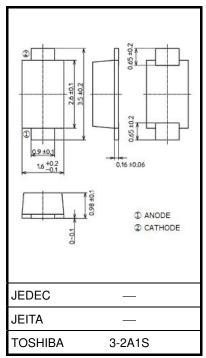
temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	V _{FM (1)}	I _{FM} = 0.1 A (pulse test)	_	0.35	_	٧
Peak forward voltage	VFM (2)	I _{FM} = 1 A (pulse test)	_	0.415	_	
	V _{FM} (3)	I _{FM} = 3 A (pulse test)	_	0.47	0.52	
Repetitive peak reverse current	I _{RRM (1)} V _{RRM} = 5 V (pulse test)			0.8		^
nepetitive peak reverse current	I _{RRM (2)}	V _{RRM} = 30 V (pulse test)		10	50	μА
Junction capacitance	Cj	V _R = 10 V, f = 1 MHz		90		pF
Thermal resistance (junction to ambient)	Du a	Device mounted on a ceramic board board size : 50 mm × 50 mm soldering land size : 2 mm × 2 mm board thickness : 0.64 mm	_		70	20044
	Rth (j-a)	Device mounted on a glass-epoxy board board size : 50 mm × 50 mm soldering land size : 6 mm × 6 mm board thickness : 1.6 mm	_	_	140	°C/W
Thermal resistance (junction to lead)	R _{th (j-l)}	_		_	20	°C/W

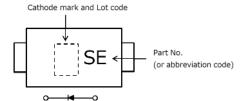
Start of commercial production 2008-08



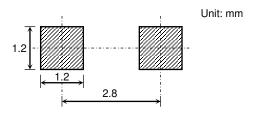
Weight: 0.013 g (typ.)

Marking

Abbreviation Code	Part No.		
SE	CRS15		



Land pattern dimensions for reference only



Handling Precaution

- Schottky barrier diodes have reverse current characteristic compared to other diodes.
 There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage.
 Please take forward and reverse loss into consideration during design.
- 2) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. The following are the general derating methods that we recommend when you design a circuit with a device.

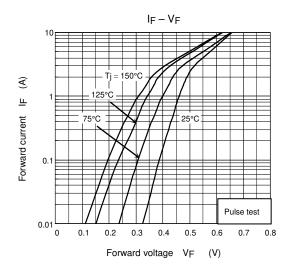
VRRM: Use this rating with reference to the above. VRRM has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.

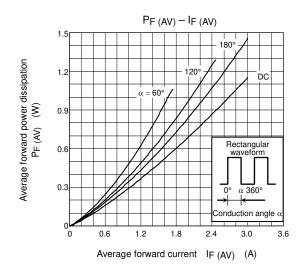
IF(AV) and IF(DC): We recommend that the worst case current be no greater than 80% of the absolute maximum rating of IF(AV) and T_j be below 120°C. When using this device, take the margin into consideration by using an allowable Ta max-IF(AV) curve.

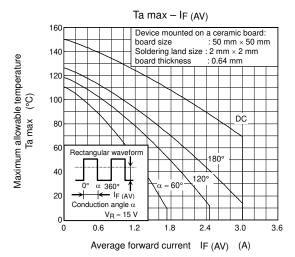
IFSM: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.

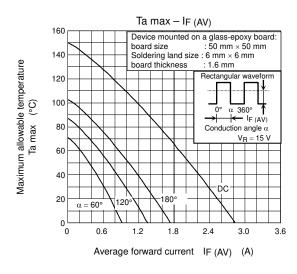
 T_j : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_j of below 120°C.

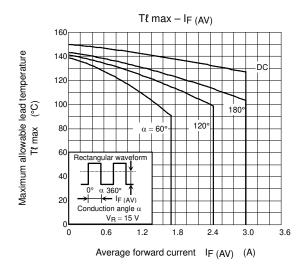
- 3) Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.
- 4) For other design considerations, see the Toshiba website.

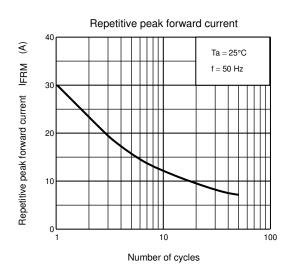




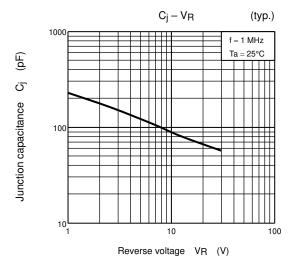


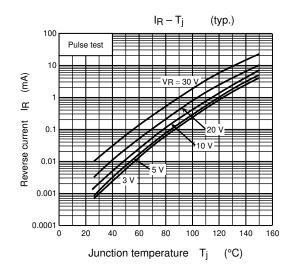


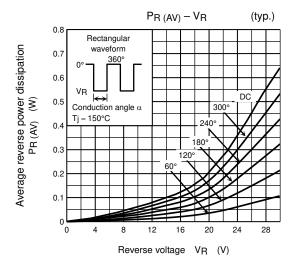


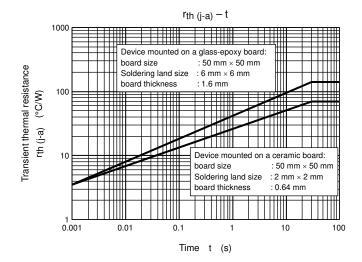


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